PRODUCT SPECIFICATIONS

For Customer: _____ □ : APPROVAL FOR SPECIFICATION

Module No.: BD-T101BAH-02

Date : 2015-01-07

Table of Contents

No.	Item	Page					
1	Cover Sheet(Table of Contents)						
2	Revision Record						
3	General Specifications						
4	Outline Drawing						
5	Absolute Maximum Ratings						
6	Electrical Specifications and Instruction Code						
7	Optical Characteristics						
8	Reliability Test Items and Criteria						
9	Quality Level						
10	Packing Reliability						

For Customer's Acceptance:

Approved By	Comment

PREPARED	CHECKED	VERIFIED BY QA DEPT	VERIFIED BY R&D DEPT

2. Revision Record

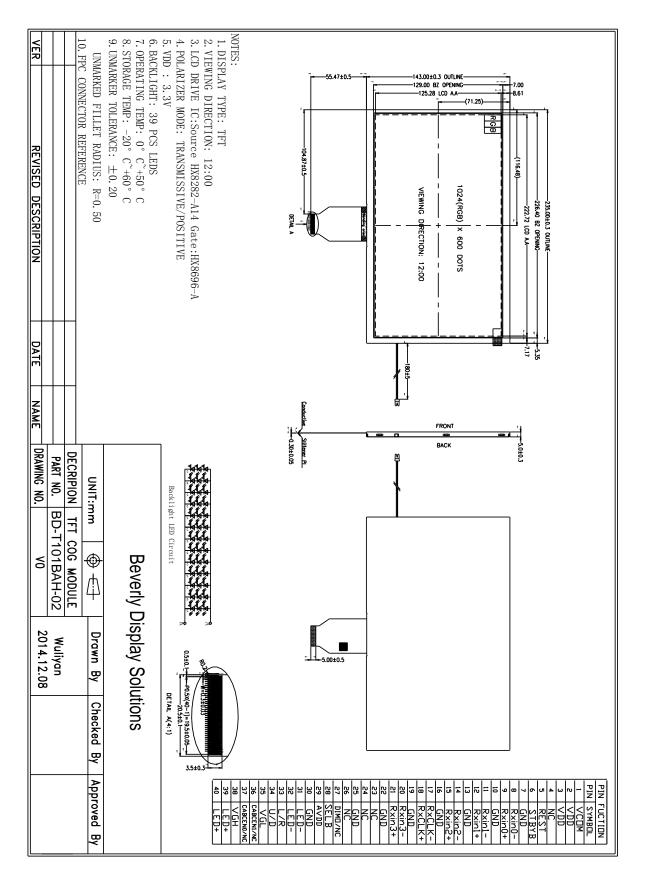
Date	Rev.No.	Page	Revision Items	Prepared
2015-01-07	V0		The first release	ZHP

3. General Specifications

BD-T101BAH-02 is a TFT-LCD module. It is composed of a TFT-LCD panel, driver IC, FPC, a back light unit. The $10.1^{\prime\prime}$ display area contains 1024×600 pixels and can display up to 16.7M colors. This product accords with RoHS environmental criterion.

Item	Contents	Unit	Note
LCD Type	TFT	-	
Display color	16.7M		
Viewing Direction	12	O'Clock	
Gray scale inversion direction	6	O'Clock	
Operating temperature	-20~+70	°C	
Storage temperature	-30~+80	°C	
Module size	Refer to outline drawing	mm	
Active Area(W×H)	222.27X125.28	mm	
Number of Dots	1024×600	dots	
Controller	HX8282A14+HX8696	-	
Power Supply Voltage	3.3	V	
Outline Dimensions	Refer to outline drawing	-	
Backlight	3X13-LEDs (white)	pcs	
Weight		g	
Interface	LVDS	-	

4. Outline Drawing



5. Absolute Maximum Ratings(Ta=25°C)

5.1 Electrical Absolute Maximum Ratings.(Vss=0V ,Ta=25°C)

ltem	Symbol	Min.	Max.	Unit	Note
	V_{DD}	-0.3	5.0	V	1, 2
	AV_{DD}	6.5	13.5	V	
Power Supply Voltage	V_{GH}	-0.3	42.0	V	
	V_{GL}	-20	0.3	V	
	V_{GH} - V_{GL}	-	40.0	V	

Notes:

- If the module is above these absolute maximum ratings. It may become permanently damaged.
 Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
- 2. V_{CC} > V_{SS} must be maintained.

5.2 Typical operation conditions

			Values			
ltem	Symbol	Min.	Тур.	Max.	Unit	Remark
	VDD	3.0	3.3	3.6	V	
Power voltage	AVDD	10.2	10.5	10.8	V	
	VGH	20	21	22	V	
	VGL	-5.0	-5.5	-6.0	V	
Input signal voltage	VCOM	3.3	3.7	4.2	V	
Input logic high voltage	VIH	0.7 VDD	-	VDD	V	
Input logic low voltage	VIL	0	-	0.3VDD	V	

5.3 Environmental Absolute Maximum Ratings.

Item	Stor	age	Operat	Note	
item	MIN.	MAX.	MIN.	MAX.	NOLE
Ambient Temperature	-30 °C	80 ℃	-20 °C	70 ℃	1,2
Humidity	-	-	-	-	3

1. The response time will become lower when operated at low temperature.

2. Background color changes slightly depending on ambient temperature.

The phenomenon is reversible.

3. Ta<=40°C:85%RH MAX.

Ta>=40°C:Absolute humidity must be lower than the humidity of 85%RH at 40°C.

6. Electrical Specifications and Instruction Code

Paramet	ter	Symbol	Condition	Min	Тур	Max	Unit	Note
Power su	pply	VCC	Ta=25° ℃	3.0	3.3	3.6	V	
Input	'H'	V _{IH}	V _{CC} =3.3V	0.8V _{CC}	-	V _{CC}	V	
voltage	'L'	V _{IL}	V _{CC} =3.3V	0	-	$0.2V_{CC}$	V	
Curren	ıt	I _{CC1}	Normal mode	-	50	-	mA	2
Consump	tion	I _{CC2}	Sleep mode	-	0.2	-	mA	2
Clock Frequen		fськ	-	-	50	-	MHz	

6.1 Electrical characteristics(Vss=0V ,Ta=25°C)

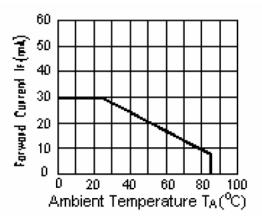
Note:

1:When an optimum contrast is obtained in transmissive mode.

2: Tested in 1×1 chessboard pattern.

6.2 LED backlight specification(VSS=0V ,Ta=25°C)

Item	Symb ol	Condition	Min	Тур	Max	Unit	Note
Supply voltage	Vf	lf=20X13mA	-	9.0	-	V	
Uniformity	∆ Вр	lf=20X13mA	70			%	
Luminance for LCD	Lv	lf=20X13mA	-	350		Cd/m2	
Life Time	Т	lf=20X13mA	-	30000		Hours	



ILED VS TEMP

6.3 Interface signals

Pin No.	Symbol	I/O	Function		
1	VCOM	Р	Common voltage		
2-3	VDD	Р	Power for digital circuit		
4	NC	-	No connect		
5	REST	1	Global reset pin		
6	SBYB	I	Stand mode: SBYB=1,normal operation SBYB=0,timing control,source driver will turn off,all output are hight-Z		
7	GND	Р	Ground		
8	RXIN0-	I	-LVDS differential data input		
9	RXIN0+	I	+LVDS differential data input		
10	GND	Р	Ground		
11	RXIN1-	I	-LVDS differential data input		
12	RXIN1+	I	+LVDS differential data input		
13	GND	Р	Ground		
14	RXIN2-	I	-LVDS differential data input		
15	RXIN2+	I	+LVDS differential data input		
16	GND	Р	Ground		
17	RXCLKIN-	I	-LVDS differential clock input		
18	RXCLKIN+	I	+LVDS differential clock input		
19	GND	Р	Ground		
20	RXIN3-	Ι	-LVDS differential data input		
21	RXIN3+	I	+LVDS differential data input		
22	GND	Р	Ground		
23-24	NC	-	No connection		
25	GND	Р	Ground		
26	NC	-	No connection		
27	DIMO	I	Blacklight CABC controller signal output		
28	SELB	I	6bit/8bit select H:6bit, L:8bit		
29	AVDD	Р	Power for analog circuit		
30	GND	Р	Ground		
31-32	LED-	Р	LED Cathode		
33	L/R		Horizonal inversion		
34	U/D		Vertical inversion		
35	VGL	Р	Negative power for TFT		
36	CABCEN1	I	CABC H/W enable		

37	CABCEN0	I	CABC H/W enable
38	VGH	Р	Positive power for TFT
39-40	LED+	Р	LED Anode

NOTE:

tting of scan cor	trol input	Scanning direction
U/D	L/R	
DVDD	DVDD	Up to down, left to right
GND	DVDD	Down to up, left to right
DVDD	GND	Up to down, right to left
GND	GND	Down to up, right to left

7. Optical Characteristics

Item	Sy	mbol	Condition	Min.	Тур.	Max.	Unit	Note
Brightness	I	Зр	<i>θ</i> =0°	-	350	-	Cd/m ²	1
Uniformity		∃Вр	Ф =0°	70	-	-	%	1,2
	3	:00		-	60	-		
Viewing	6	:00	0->40	-	45	-	D	0
Angle	9	:00	Cr≥10	-	60	-	Deg	3
	12	2:00		-	60	-		
Contrast Ratio	Ratio Cr		<i>θ</i> =0°	300	500		-	4
Response			0=0° Φ=0°	-	10	-	ms	5
Time				-	10	-	ms	5
	W	х			0.28		-	
	vv	У			0.33		-	
	R	х			0.51		-	
Color of CIE		у			0.34		-	
Coordinate	^	<i>θ</i> =0°		0.31		-	1,6	
	G	У	Ф = 0°		0.56		-	
	В	х			0.15		-	
	D	у			0.14		-	
NTSC Ratio	S			50	60	-	%	

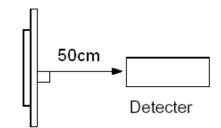
Note: The parameter is slightly changed by temperature, driving voltage and materiel

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment PR-705 (Φ8mm)

Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: Ta=25°C.
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.

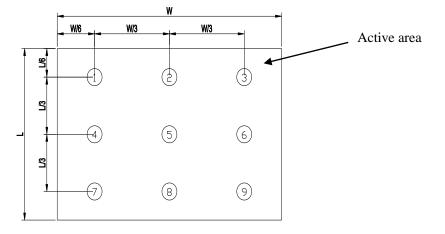


Note 2: The luminance uniformity is calculated by using following formula.

∠Bp = Bp (Min.) / Bp (Max.)×100 (%)

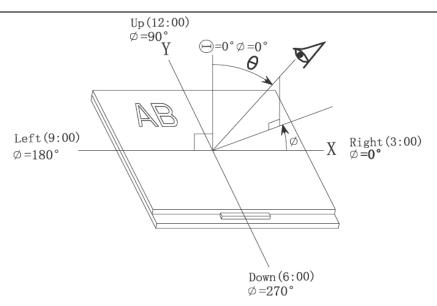
Bp (Max.) = Maximum brightness in 9 measured spots

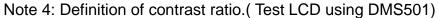
Bp (Min.) = Minimum brightness in 9 measured spots.

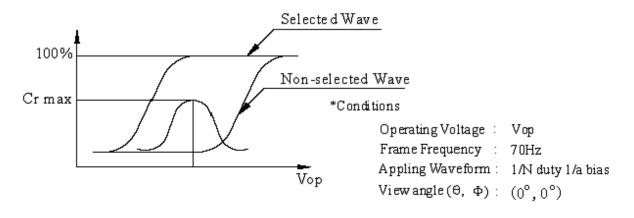


Note 3: The definition of viewing angle:

Refer to the graph below marked by heta and $m \phi$



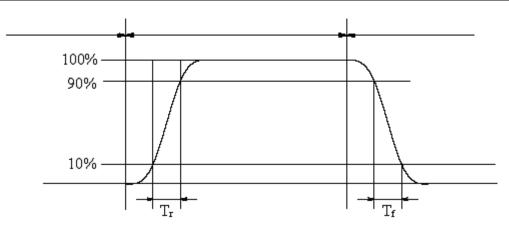




Contrast ratio(
$$Cr$$
) = $\frac{Brightness \ of \ selected \ dots}{Brightness \ of \ non-selected \ dots}$

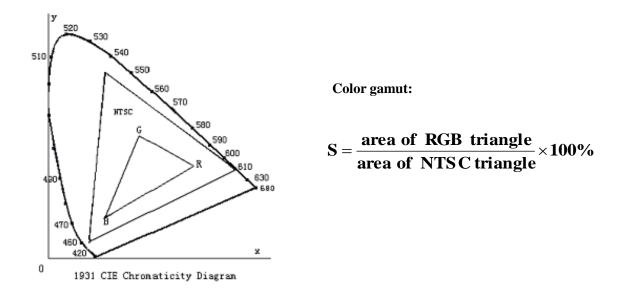
Note 5: Definition of Response time. (Test LCD using DMS501):

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



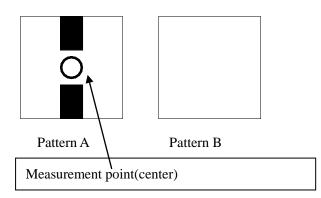
The definition of response time

Note 6: Definition of Color of CIE Coordinate and NTSC Ratio.



Note 7: Definition of cross talk.

Cross talk ratio(%)=|pattern A Brightness-pattern B Brightness|/pattern A Brightness*100



Electric volume value=3F+/-3Hex

8. Reliability Test Items and Criteria

No	Test Item	Test condition	Criterion
1	High Temperature Storage	80℃±2℃ 96H Restore 2H at 25℃ Power off	
2	Low Temperature Storage	-30℃±2℃ 96H Restore 2H at 25℃ Power off	
3	High Temperature Operation70°C±2°C 96HRestore 2H at 25°CPower on		1. After testing, cosmetic and electrical defects should not
4	Low Temperature Operation	-20℃±2℃ 96H Restore 4H at 25℃ Power on	happen. 2. Total current consumption should not be more than twice
5	High Temperature/Humidity Operation	60℃±2℃ 90%RH 96H Power on	of initial value.
6	Temperature Cycle	-30°C →80°C 30min 5min 30min after 5 cycle, Restore 2H at 25°C Power off	
7	Vibration Test	10Hz~150Hz, 100m/s ² , 120min	Not allowed cosmetic
8	Shock Test	Half- sine wave,300m/s ² ,11ms	and electrical defects.

Note: Operation: Supply 2.8V for logic system.

The inspection terms after reliability test, as below

ITEM	Inspection
Contrast	CR>50%
IDD	IDD<200%
Brightness	Brightness>60%
Color Tone	Color Tone+/-0,05

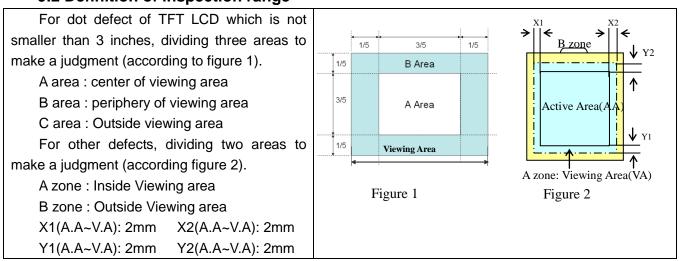
9 Quality level

9.1 Classification of defects

Major defects (MA): A major defect refers to a defect that may substantially degrade usability for product applications, including all functional defects(such as no display, abnormal display, open or missing segment, short circuit, missing component), outline dimension beyond the drawing, progressive defects and those affecting reliability.

Minor defects (MI): A minor defect refers to a defect which is not considered to be able to substantially degrade the product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation, such as black spot, white spot, bright spot, pinhole, black line, white line, contrast variation, glass defect, polarizer defect, etc.

9.2 Definition of inspection range



9.3 Inspection items and general notes

General notes	 Should any defects which are not specified in this standard happen, additional standard shall be determined by mutual agreement between customer and our company. Viewing area should be the area which our company guarantees. Limit sample should be prior to this Inspection standard. Viewing judgment should be under static pattern. Inspection conditions Inspection distance: 250 mm (from the sample) Temperature : 25±5 °C Inspection angle : 45 degrees in 6 o'clock direction (all defects in viewing area should be inspected from this direction) 				
Pinhole, Bright spot, Black spot, White spot, Black line, White Line, Foreign particle, Bubble		The color of a small area is different from the remainder. The phenomenon doesn't change with voltage			
Inspection items	Contrast variation	The color of a small area is different from the remainder. The phenomenon changes with voltage			
	Polarizer defect	Scratch, Dirt, Particle, Bubble on polarizer or between polarizer and glass			

Dot defect (TFT LCD)	The pixel appears bright or dark abnormally when display
Functional defect	No display, Abnormal display, Open or missing segment, Short circuit, False viewing direction
Glass defect	Glass crack, Shaved corner of glass, Surplus glass
PCB defect	Components assembly defect

9.4 Outgoing Inspection level

Outgoing Inspection	Inspection conditions		Inspection					
standard			Max.	Unit	L	AQL		
Major Defects	See 9.3 general notes	See 9.5			Π	0.65		
Minor Defects	s See 9.3 general notes		See 9.8	5	Ξ	0.65		
Note: Sampling standard conforms to GB2828								

9.5 Inspection Items and Criteria

				Judgment standard				
	Inspec	tion items		Category	Acceptable r	number		
				Calegory	A zone	B zone		
			А	Ф<=0.10	Neglected			
	Black spot, White spot,	b ↓	В	0.10<Ф<=0.2	1			
1	Pinhole, Foreign Particle, Particle	a	С	0.2<Ф	0	Neglected		
	in or on glass, Scratch on glass	$\Phi = (a+b)/2(m)$		-	-			
			Total defective point(B,C)		1			
		W: Width		W<=0.02	Neglected			
	Black line, White				В	0.02 <w<=0.03 L<=1.0</w<=0.03 	1	
2	line, and Particle Between Polarizer and	L:Length(mm)	с	0.03 <w<=0.05 L>1.0</w<=0.05 	0	Neglected		
	glass, Scratch on glass	D	0.05 <w, 1.0<l<="" td=""><td>0</td><td></td></w,>	0				
			Total defective point(B,C)		1			
3	Bright spot		any size		none	none		

			<u> </u>				
			А	Φ<0.2	Neglected		
		b	В	0.2<Ф<=0.3	2	Neglecte	
4	Contrast variation	$\langle a \rangle \qquad \forall$	С	0.3<Ф<=0.4	1	d	
	Vallation	$\Phi = (a+b)/2(mm)$	D	0.4<Φ	0		
			То	tal defective point(B,C)	3		
5	Bubble inside cell			any size	none	none	
	Polarizer defect	Scratch ,damage on polarizer, Particle on polarizer or between polarizer and glass.	Refer to item 1 and item 2.				
6	(if Polarizer is used)	Bubble, dent and convex	A	Φ<=0.1	Neglected		
			В	0.1 <Φ<=0.2	1	Neglecte d	
			С	0.2 <Ф	0		
		Stage surplus glass				1	
	Sumbro	>	B<=0.3mm				
7	Surplus glass	Surrounding surplus glass	Should not influence outline dimension and assembline				
8	Open segment or o	open common	Not permitted				
9	Short circuit		Not	permitted			
10	⁰ False viewing direction		Not permitted				
11	1 Contrast ratio uneven		According to the limit specimen				
12	2 Crosstalk		According to the limit specimen				
13	³ Black /White spot(display)		Refer to item 1				
14	4 Black /White line(display)			Refer to item 2			

Inspection items	Judgment standard
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				Category(application: B zone)	Acceptable number
		i) The front of lead terminals	A	a≤ t, b≤1/5W, c≤3mm	
		w t a c	В	Crack at two sides of lead terminals should not cover patterns and alignment mark	
	Glass	ii) Surrounding crack-non-contact side	b <	< Inner borderline of the seal	Max.3
15	defect crack	iii) Surrounding crack- contact side seal c b a <u>Inner border line of the seal</u> Outer border line of the seal	b -	< Outer borderline of the seal	defects allowed
		iv) Corner	А	a <= t, b <= 3.0, c <= 3.0	
		w b c	В	Glass crack should not cover patterns u and alignment mark and patterns.	

Inspection items	Judgment standard
	Category(application: B zone)

		Component soldering: No cold soldering, short, open circuit, burr, tin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2) lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted	Component U L < W/2 Soldering pad Lead L2>0
16	PCB defect	Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted	bead Base Board Soldering tin is not permit in this area Soldering tin is not permit in this area
		Glue on root of the speaker receiver and motor lead: The insulative coat of the lead must join into the PCB; the protected glue must envelop to the insulative coat.	Glue PCB Insulative coat

10. Precautions for Use of LCD Modules

10.1 Handling Precautions

- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol
 - Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:
 - Water
 - Ketone
 - Aromatic solvents
- 10.1.6 Do not attempt to disassemble the LCD Module.
- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.

d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : $0^\circ C \sim 40^\circ C$

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.